		line 5, change "Technical Field" to -BACKGROUND OF THE
92	DIVENITION	
40	INVENTION-;	
-03		between lines 5 and 6, insert - 1. Field of the Invention -; and
		line 8, change "Background Art" to - 2. Description of Related Art
ay	Page 2,	before line 3, insert SUMMARY OF THE INVENTION -; and
45		line 6, delete "Disclosure of the Invention".
<u>-</u>	Page 4,	line 20, change "Brief Description of the Drawings" toBRIEF
_ab	DESCRIPTION OF THE DRAWINGS	
	Pages 7-8	delete the pages in their entirety.
The state of the s	Page 9,	delete lines 1-14 in their entirety; and
		line 16, change "Best Mode for Carrying Out the Invention" to
	DETAILED DE	SCRIPTION OF THE PREFERRED EMBODIMENTS
9	DITHE CLAIMS.	
<u> </u>	IN THE CLAIMS:	
<u>.</u> 	Please amend claims 1-20 as follows:	
	1. (Amer	nded) A three-dimensional device comprising:
	a plura	ality of thin film device layers deposited in a thickness direction, each thin
	film device layer	being disposed in a predetermined region in a planar direction, [wherein] at
	least one of the th	in film device ayers [is] being deposited by a transfer method.
	2. (Amer	nded) A three dimensional device comprising:
	a plura	ality of thin film device layers deposited on a base in a thickness direction
	for constituting a	three-dimensional circuit, each thin film device layer constituting a circuit
•	disposed in a pred	determined region extending in a planar direction, [wherein] at least one of

the thin film device layers [is] being deposited by a transfer method.